

SID

Factory: Rot am See

Article:

ML6

Provided:

Customer:

Date:

03.04.2026

WÜRTH  
ELEKTRONIK  
MORE THAN  
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	425		2	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		3	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		4	
		105	L2		
C-RaS-FR4-ML-0.711mm-105+105-TG150-HF...	50203137	710		5	A01
		105	L3		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	54		6	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	320		7	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		8	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		9	B00
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	54		10	
		105	L4		
C-RaS-FR4-ML-0.711mm-105+105-TG150-HF...	50203137	710		11	A02
		105	L5		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	425		12	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		13	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		14	
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	15	

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

3188 µm

Version 1.2.20.35

© Würth Elektronik